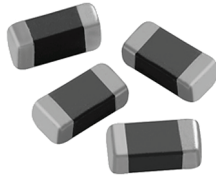


## Monolithic Chip Inductors



### MECHANICAL SPECIFICATIONS

**Solderability:** 90 % coverage after 5 s dip in 235 °C solder following 60 s preheat at 120 °C to 150 °C and type R flux dip

**Resistance to Solder Heat:** 10 s in 260 °C solder, after preheat and flux per above

**Termination:** 100 % Sn

**Terminal Strength:** 0.1 kg for 30 s

**Beam Strength:** 2.5 kg

### FEATURES

- High reliability
- Surface mountable
- Magnetically self shielded
- Nickel barrier plating virtually eliminates silver migration
- Compliant to RoHS directive 2002/95/EC



**RoHS**  
COMPLIANT

### ENVIRONMENTAL SPECIFICATIONS

**Operating Temperature:** - 55 °C to + 125 °C

**Thermal Shock:** - 40 °C to + 85 °C

**Humidity:** 90 % RH at 40 °C, 1000 h at full rated current

**Load Life:** 85 °C for 1000 h at full rated current

### STANDARD ELECTRICAL SPECIFICATIONS

IND. AT ± 10 % (μH)	TOL.	THICKNESS "D" (INCHES [mm])	TEST FREQ. (MHz)	Q MIN.	SRF MIN. (MHz)	DCR MAX. (Ω)	RATED DC CURRENT (mA)
			L & Q				
0.047	20 %	0.043 ± 0.012 [1.10 ± 0.3]	50	20	368	0.15	300
0.068	20 %	0.043 ± 0.012 [1.10 ± 0.3]	50	20	322	0.25	300
0.10	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	271	0.25	250
0.12	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	253	0.30	250
0.15	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	230	0.30	250
0.18	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	213	0.40	250
0.22	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	196	0.40	250
0.27	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	173	0.50	250
0.33	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	20	167	0.60	250
0.39	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	25	156	0.50	200
0.47	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	25	144	0.60	200
0.68	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	25	121	0.80	150
0.82	10 %	0.043 ± 0.012 [1.10 ± 0.3]	25	25	115	0.90	150
1.0	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	87	0.40	100
1.2	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	75	0.50	100
1.5	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	69	0.50	50
1.8	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	64	0.50	50
2.2	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	58	0.50	50
3.3	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	48	0.70	50
3.9	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	44	0.80	50
4.7	10 %	0.043 ± 0.012 [1.10 ± 0.3]	10	45	41	0.90	50
5.6	10 %	0.043 ± 0.012 [1.10 ± 0.3]	4	45	37	0.70	25
6.8	10 %	0.043 ± 0.012 [1.10 ± 0.3]	4	45	34	0.80	25
8.2	10 %	0.043 ± 0.012 [1.10 ± 0.3]	4	45	30	0.90	25
10	10 %	0.043 ± 0.012 [1.10 ± 0.3]	2	45	28	1.00	25
12	10 %	0.043 ± 0.012 [1.10 ± 0.3]	2	45	26	1.05	15
15	10 %	0.043 ± 0.012 [1.10 ± 0.3]	1	45	22	0.70	5
18	10 %	0.043 ± 0.012 [1.10 ± 0.3]	1	45	21	0.70	5
22	10 %	0.043 ± 0.012 [1.10 ± 0.3]	1	35	19	0.90	5
27	10 %	0.043 ± 0.012 [1.10 ± 0.3]	1	35	17	0.90	5
33	10 %	0.043 ± 0.012 [1.10 ± 0.3]	1	35	15	1.05	5

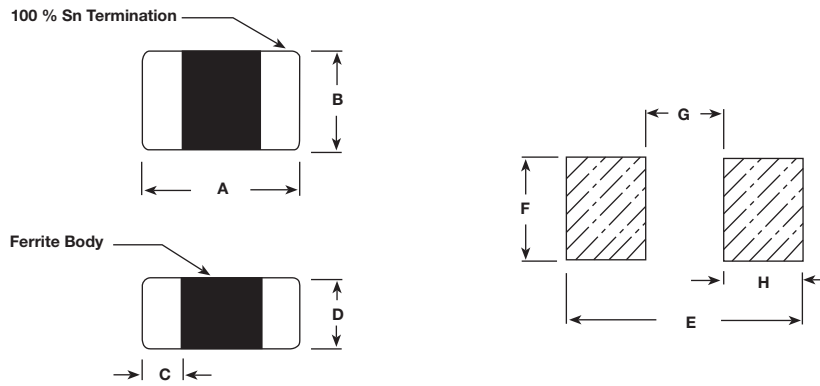
### DESCRIPTION

<b>ILSB-1206</b>	<b>3.3 μH</b>	<b>± 10 %</b>	<b>ER</b>	<b>e3</b>
MODEL	INDUCTANCE VALUE	INDUCTANCE TOLERANCE	PACKAGE CODE	JEDEC LEAD (Pb)-FREE STANDARD

### GLOBAL PART NUMBER

<b>I</b>	<b>L</b>	<b>S</b>	<b>B</b>	<b>1</b>	<b>2</b>	<b>0</b>	<b>6</b>	<b>E</b>	<b>R</b>	<b>3</b>	<b>R</b>	<b>3</b>	<b>K</b>
PRODUCT FAMILY				SIZE				PACKAGE CODE		INDUCTANCE VALUE			TOL.

**DIMENSIONS** in inches [millimeters]

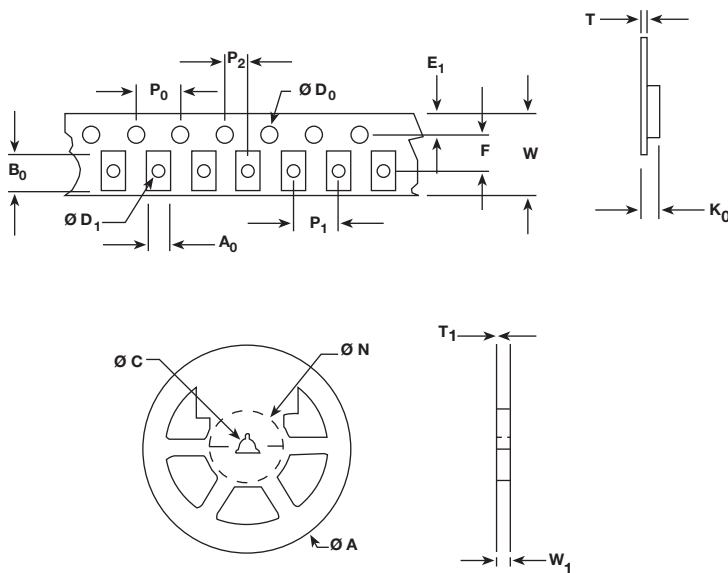


Dimensional Outline

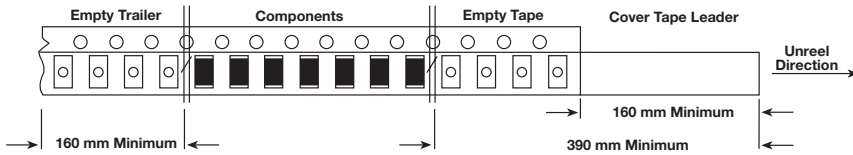
Suggested Pad Layout

A	B	C	D	E	F	G	H
0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.020 ± 0.012 [0.5 ± 0.3]	0.043 ± 0.012 [1.10 ± 0.3]	0.185 [4.7]	0.070 [1.8]	0.087 [2.2]	0.047 [1.2]

**TAPE AND REEL SPECIFICATIONS 1206 SIZE PER EIA-481-1** in inches [millimeters]



A <sub>0</sub>	0.073 ± 0.004 [1.85 ± 0.1]
B <sub>0</sub>	0.135 ± 0.004 [3.43 ± 0.1]
D <sub>0</sub>	0.059 + 0.005/- 0.000 [1.5 + 0.127]
D <sub>1</sub>	0.039 min. [1.0 min.]
E <sub>1</sub>	0.069 ± 0.004 [1.75 ± 0.1]
F	0.138 ± 0.002 [3.50 ± 0.05]
K <sub>0</sub>	0.048 ± 0.002 [1.22 ± 0.05]
P <sub>0</sub>	0.157 ± 0.004 [4.00 ± 0.1]
P <sub>1</sub>	0.157 ± 0.004 [4.00 ± 0.1]
P <sub>2</sub>	0.079 ± 0.002 [2.00 ± 0.05]
W	0.327 max. [8.3 max.]
T	0.008 ± 0.002 [0.2 ± 0.05]
A	7.000 ± 0.079 [178 ± 2.0]
N	2.500 [63.5]
C	0.512 ± 0.020 [13.00 ± 0.50]
W <sub>1</sub>	0.315 + 0.059/- 0.000 [8.00 + 1.5]
T <sub>1</sub>	0.079 ± 0.002 [2.00 ± 0.05]





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